Unit: mm

(1.0)

# **2SB0819** (2SB819)

# Silicon PNP epitaxial planar type

For low-frequency output amplification Complementary to 2SD1051

### ■ Features

- ullet High collector-emitter voltage (Base open)  $V_{CEO}$
- Large collctor power dissipation P<sub>C</sub>
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-50	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-40	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	-5	V	
Collector current	$I_C$	-1.5	A	
Peak collector current	I <sub>CP</sub>	-3	A	
Collector power dissipation *	P <sub>C</sub>	1	W	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

Note) \*: Print circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

# (0.1 0.45±0.05 3: Emitter M-A1 Package

## ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

	-			X	M-A	I Package	
Peak collector current	I <sub>CP</sub>	-3 A	•	11/1			
Collector power dissipation * P <sub>C</sub> 1 W							
Junction temperature T <sub>j</sub> 150 °C							
Storage temperature T <sub>stg</sub> -55 to +150 °C							
Collector power dissipation * P <sub>C</sub> 1 W  Junction temperature T <sub>j</sub> 150 °C  Storage temperature T <sub>sig</sub> -55 to +150 °C  Note) *: Print circuit board: Copper foil area of 1 cm <sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion  ■ Electrical Characteristics T <sub>a</sub> = 25°C ± 3°C							
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = -1 \text{ mA}, I_E = 0$	-50			V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 2 \text{ mA}, I_B = 0$	-40			V	
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -20 V_{CE} = 0$			-1	μΑ	
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = -10 \text{ V}, I_{B} = 0$			-100	μΑ	
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = -5 \text{ V}, I_C = 0$			-10	μΑ	
Forward current transfer ratio *1, 2	$h_{FE}$	$V_{CE} = -5 \text{ V}, I_{C} = -1 \text{ A}$	80		220	_	
Collector-emitter saturation voltage*	V <sub>CE(sat)</sub>	$I_C = -1.5 \text{ A}, I_B = -0.15 \text{ A}$			-1	V	
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_C = -2 A, I_B = -0.2 A$			-1.5	V	
Transition frequency	$f_T$	$V_{CB} = -5 \text{ V}, I_E = 0.5 \text{ A}, f = 200 \text{ MHz}$		150		MHz	
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = -20 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		45		pF	

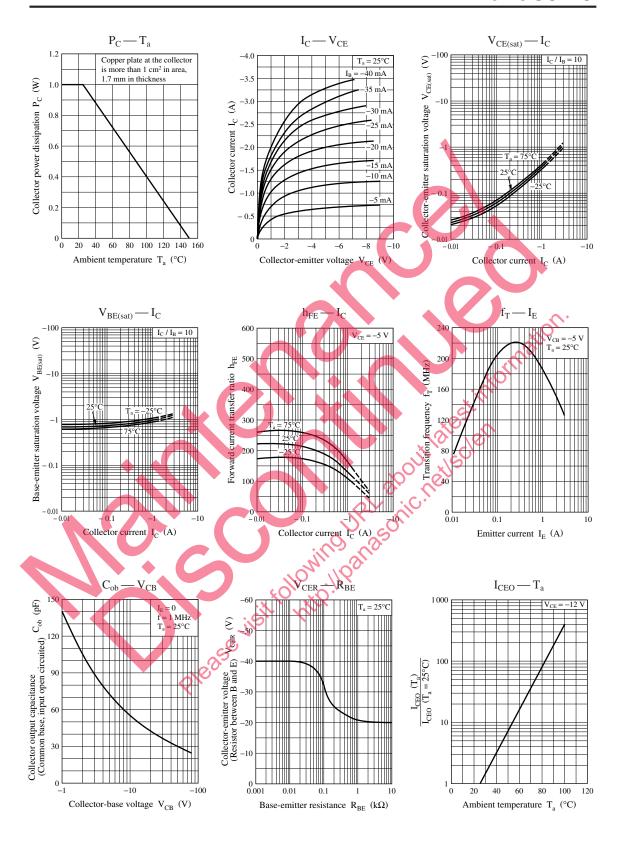
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

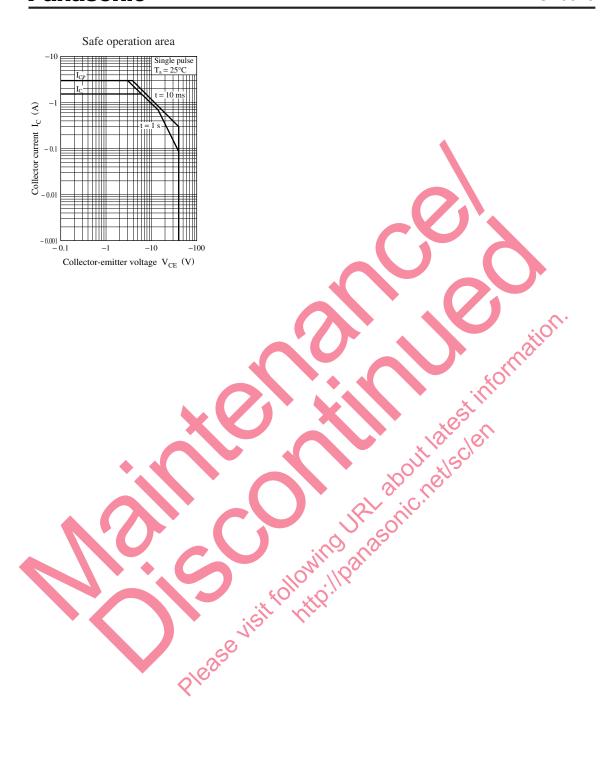
### 2. \*1: Pulse measurement

#### \*2: Rank classification

Rank	Q	R
$h_{FE}$	80 to 160	120 to 220

Note) The part number in the parenthesis shows conventional part number.





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